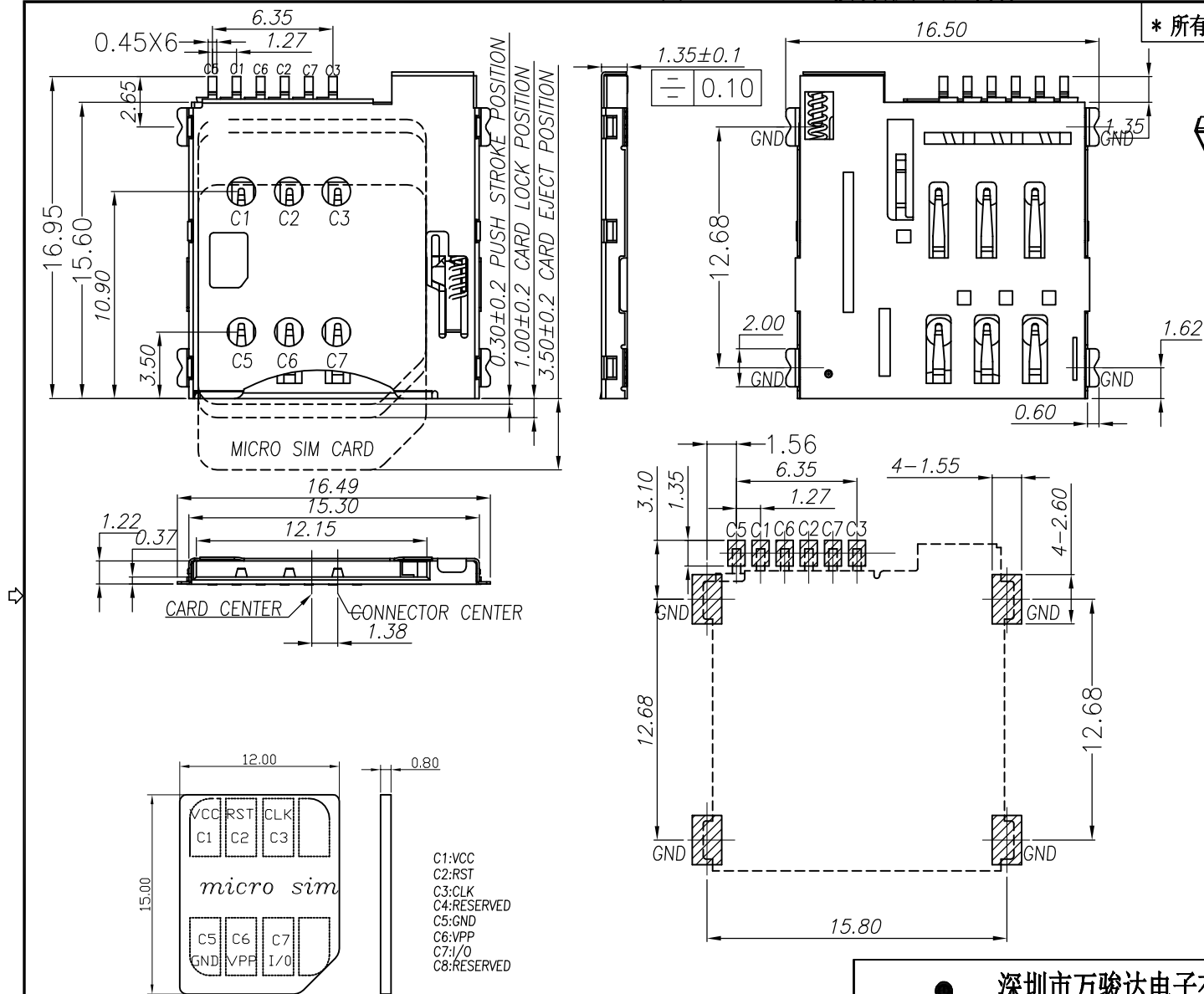


* 所有原材料, 生产制程, 电镀必须符合ROHS要求



Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:

Current Rating :0.5mA AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m Ω
Insulation Resistance:1000M min./500VDC
Mating Cycles:10,000 Insertions
产品耐温温度: 260° C⁻¹ < 180° C⁻¹ < 170° C⁻¹



深圳市万骏达电子有限公司

<http://www.wanjunda.com>

品名 (ITEM NO)	MICRO SIM PUSH 6PIN 1.35	图号 (DWG NO)		单位 (UNIT): MM
料号 (PART NO)	MICRO-SIM-PUSH-6P-1.35	本 (REV)		比例 (SCALE) 1:1
模号 (MODEL NO)		日期 (DATE)		
		设计 (DESIGN)		未注公差 TOLERANCE UNSPECIFIED
		审核 (CHECKED)		X.X ±0.30
		核准 (APPROVED)		X.XX ±0.15
				X.XXX ±0.10
				X' ±5'
				X.X' ±2'